

PCB REMOVAL KEY:

 $oldsymbol{\Theta}$

WINDOW OPENING AND A WIDE AT APPROX. 12-1/2"
(. 12-1/2" BENEATH EXTERIOR CONCRETE SILL. DELINEATE
OR VERTICAL LINE AT APPROX. 22" EITHER SIDE OF
W OPENING AND HORIZONTAL LINE APPROX. 22" (WHERE IBLE) BENEATH INTERIOR CONCRETE SILL. CLEAN AND ULATE CONCRETE SILL. CLEAN AND ENCAPCY
ORTAR SURFACES WITHIN FOR

E AND DISPOSE OF METAL WINDOW SYSTEMS. SAW CUT OR VERTICAL LINE \$\frac{1}{4}" DEEP AND \$\frac{1}{4}" WIDE AT APPROX. 12-1/2" SIDE OF WINDOW OPENING AND HORIZONTAL LINE 12-1/2" BENEATH WINDOW OPENING. DELINEATE OR VERTICAL LINE AT APPROX. 22" EITHER SIDE OF AND 14 WINDOW OPENING. CLEAN AND ENCAPSULATE INTERIOR ETE SILL WHERE ACCESSIBLE. CLEAN AND ENCAPSULATE WORTAR SURFACES WITHIN EXTERIOR SAW CUTS AND TO DE TAIS ATENTAL.

(A)

SAW CUT

REMOVE AND DISPOSE OF METAL DOOR SYSTEMS. SAEXTERIOR VERTICAL LINE $\frac{1}{4}$ " DEEP AND $\frac{1}{4}$ " WIDE AT AI EITHER SIDE OF DOOR OPENING. DELINEATE INTERILINE AT APPROX. 22" EITHER SIDE OF DOOR OPENINENCAPSULATE INTERIOR CONCRETE, BRICK AND MORIS IN CONTACT WITH CAULK EXTERIOR 12-1/2" FROM LINEAND INTERIOR 22" FROM CAULK LINE. IDE AT APPROX. 12-1/2"
E INTERIOR VERTICAL
COPENING. CLEAN AND
AND MORTAR WHERE IT
1/2" FROM CAULK

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REMOVE AND DISPOSE OF METAL WINDOW SYSTEMS. RESIDUAL CAULK FROM WINDOW OPENINGS. CLEAN

MOVE AND DISPOSE OF METAL WINDOW SYSTEMS. CLEAN SIDUAL CAULK FROM WINDOW OPENINGS INCLUDING BEAMS. EAN AND ENCAPSULATE ENTIRE CONCRETE BEAM INTERIOR AND

REMOVE AND DISPOSE OF METAL WINDOW SYSTEMS. CLEAN RESIDUAL CAULK FROM WINDOW OPENING INCLUDING SILLS. SAW CUT EXTERIOR VERTICAL LINE APPROXIMATELY 12-1/2" EITHER SIDE OF CAULK LINE AT WINDOW OPENING TO BOTTOM OF SILL. DELINEATE INTERIOR VERTICAL LINE APPROXIMATELY 22" EITHER SIDE OF WINDOW OPENING TO BOTTOM OF SILL. CLEAN AND ENCAPSULATE ALL SURFACES WITIN EXTERIOR SAW CUTS AND INTERIOR DELINEATED LINES. CLEAN AND ENCAPSULATE ENTIRE

REMOVE AND DISPOSE OF METAL DOOR SYSTEMS. CLEAN RESIDUAL CAULK FROM DOOR FRAME OPENINGS.

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REMOVE SOIL FROM EDGE OF FOUNDATION TO 24" FROM FOUNDATION TO A DEPTH OF 4" BELOW GRADE. REMOVE SOIL FROM EDGE OF FOUNDATION TO 36" FROM FOUNDATION TO A DEPTH OF 4" BELOW GRADE.

REMOVE SOIL FROM EDGE OF FOUNDATION TO 48" FOUNDATION TO A DEPTH OF 4" BELOW GRADE.

REMOVE ALL SOIL FROM EDGE OF FOUNDATION TO A DEPTH OF BELOW ${\it GRADE}$.

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GENERAL NOTES:

AC = ASBESTOS-CONTAINING
PCB = POLY-CHLORINATED BIPHENYL

A. REMOVE AND DISPOSE OF SCHEDULED METAL WINDOW SYSTEMS INCLUDING BUT NOT LIMITED TO SASHES, FRAMES, FASTENERS AND ASSOCIATED CAULK AND GLAZING COMPOUND. WINDOW SASH GLAZING COMPOUND AND WINDOW FRAME CAULK ARE AC AND ALSO CONTAIN PCB CONCENTRATIONS IN EXCESS OF 50 PPM. DISPOSE OF SASHES, FRAMES, CAULK AND WINDOW GLAZING COMPOUND AS MIXED REGULATED ASBESTOS WASTE AND PCB BULK PRODUCT WASTE (>50 PPM) IN A TSCA APPROVED LANDFILL.

B. CLEAN AND ENCAPSULATE INTERIOR CONCRETE WHERE IT IS IN CONTACT WITH CAULK EXTERIOR 12-1/2" FROM CAULK LINE.

D. THE REMEDIATION CONTRACTOR SHALL BE RESPONSIBLE FOR MAINTAINING THE INTEGRITY OF EACH ABATEMENT AREA UNTIL CLEARANCE SAMPLING IS ACHIEVED. THE BUILDING OWNER IS REPSONSIBLE FOR PAYMENT OF THE INTIAL CLEARANCE SAMPLING ONLY. THE REMEDIATION CONTRACTOR SHALL BE RESPONSIBLE THE REMEDIATION CONTRACTOR SHALL BE RESPONSIBLE. REMOVE AND DISPOSE OF SCHEDULED METAL DOOR YSTEMS INCLUDING BUT NOT LIMITED TO FRAMES, ASTENERS AND ASSOCIATED CAULK. DOOR FRAME CAULK S AC AND ALSO CONTAINS PCB CONCENTRATIONS IN XCESS OF 50 PPM. DISPOSE OF DOOR FRAMES AND CAULK S MIXED REGULATED ASBESTOS WASTE AND PCB BULK RODUCT WASTE (>50 PPM) IN A TSCA APPROVED LANDFILL.

SHEET TITLE:

GROUND FLOOR PCB REMEDIATION PLAN

ISIBLE



135 SCHOOL ROAD

PROJECT TITLE: WESTON MIDDLE SCHOOL PCB RISK-BASED REMEDIATION ACTION PLAN

REVISIONS NO. DATE: DESCRIPTION 12/7/11 MODIFICATIONS FOR

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SIDE D

PROJECT CLIENT AND ADDRESS: WESTON PUBLIC SCHOOLS WESTON MIDDLE SCHOOL WESTON, CONNECTICUT

CONSULTANT'S SEAL

STATE PROJECT NO.

FOR CONSTRUCTION: OCTOBER 2011

SHEET NO.